

# The Third International Conference on Electrical and Electronic Engineering, Telecommunication Engineering, and Mechatronics (EEETEM2017)

<http://sdiwc.net/conferences/eeetem2017>

Faculty of Engineering - Lebanese University  
Beirut, Lebanon

April 26-28, 2017

All registered papers will be submitted to IEEE for potential inclusion to IEEE Xplore

You are invited to participate in The Third International Conference on Electrical and Electronic Engineering, Telecommunication Engineering, and Mechatronics (EEETEM2017) that will be held in Beirut, Lebanon, on April 26-28, 2017. The event will be held over three days, with presentations delivered by researchers from the international community, including presentations from keynote speakers and state-of-the-art lectures.

## RESEARCH TOPICS:

### ELECTRONICS ENGINEERING

Artificial Intelligence  
Circuits and Electronics  
Computer Architecture for Intelligent Machines  
Electronic Medical Devices  
Electronics System-Level Based Design  
Fiber Optics and Fiber Devices  
Integrated Optics  
Low-Power Signal Processing  
Mobile Computing  
Networks Design, Protocols and Management  
Radio-Frequency Integrated Circuits  
System on Chips and Network on Chips

### ELECTRICAL ENGINEERING

Analog Circuits and Digital Circuits  
Antenna and Propagation  
Bioinformatics & Biomedical Imaging  
Brain-Computer Interfacing and Human-Computer Interfacing  
Computer-Aided Surgery  
Electric Energy Processing  
Electromagnetic and Photonics  
Health Care Information Systems  
Image Processing  
Microwave Theory and Techniques  
Mobile Security  
Power IC  
Robotics and Atomization Engineering

### MECHATRONICS

Applications of AI Techniques in Design and Manufacturing  
Automation  
Industrial Engineering  
Instrumentation and Control  
Modeling and Design  
Robotics and Automation  
Robotics and Mobile Machines  
Dynamic Systems and Control  
Globalization of Engineering  
NanoEngineering for Energy  
Computer-aided design, manufacturing, and engineering  
Automobile technology  
Bio-Mechatronics  
Design and Green Manufacturing  
Human-Machine Interface  
Mechanical Engineering  
Micro-Machining  
Mechatronics  
Nano Technology  
Micromechatronics

### SPECIAL ISSUES:

- International Journal of New Computer Architectures and their Applications (IJNCAA)
- International Journal of Digital Information and Wireless Communications (IJDWC)
- International Journal of Cyber-Security and Digital Forensics (IJCSDF)
- International Journal of E-Learning and Educational Technologies in the Digital Media (IJETDM)

Submission Deadline

**February 3, 2017**

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